

BGO807; BGO807/FC0; BGO807/SC0

870 MHz optical receivers

Rev. 2 — 29 September 2010

Product data sheet

1. Product profile

1.1 General description

High dynamic range optical receiver amplifier modules in a standard SOT115 package where the non-jacketed fiber has either no connector or has an FC/APC or SC/APC connector.

The amplifier supply voltage pin and the photo diode bias voltage pin both connect to 24 V (DC).

The modules have a mono mode optical input suitable for 1290 nm to 1600 nm wavelengths, a terminal to monitor the photo diode current and an electrical output having a characteristic impedance of 75 Ω .

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Low noise
- Excellent flatness
- Standard CATV outline
- Rugged construction
- Gold metallization ensures excellent reliability
- High optical input power range.

1.3 Applications

- CATV optical node systems operating in the 40 MHz to 870 MHz frequency range.



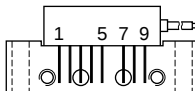
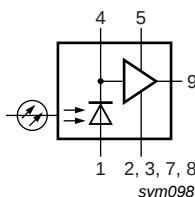
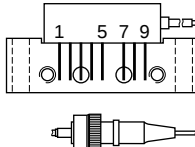
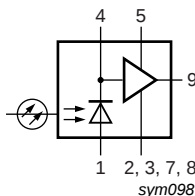
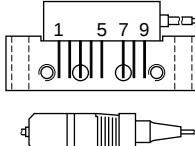
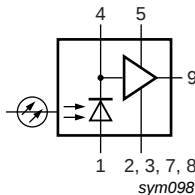
1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f	frequency range		40	-	870	MHz
S ₂₂	output return losses	f = 40 MHz to 870 MHz	11	-	-	dB
	optical input return losses		45	-	-	dB
d ₂	second order distortion	f = 854.5 MHz	-	-	-55	dB
F	equivalent noise input	f = 40 MHz to 870 MHz	-	-	8.5	pA/√Hz
I _{tot}	total current consumption (DC)	V _B = 24 V	175	-	205	mA

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BGO807 (SOT115T)			
1	monitor current		
2, 3	common		
4	+V _B of the photodiode		
5	+V _B of the amplifier		
7, 8	common		
9	output		
BGO807/FC0 (SOT115X)			
1	monitor current		
2, 3	common		
4	+V _B of the photodiode		
5	+V _B of the amplifier		
7, 8	common		
9	output		
BGO807/SC0 (SOT115Y)			
1	monitor current		
2, 3	common		
4	+V _B of the photodiode		
5	+V _B of the amplifier		
7, 8	common		
9	output		

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BGO807	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads	SOT115T
BGO807/FC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115X
BGO807/SC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115Y

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
f	frequency range		40	870	MHz
T _{stg}	storage temperature		-40	+85	°C
T _{mb}	operating mounting base temperature		-20	+85	°C
P _{in}	optical input power	continuous	-	5	mW
ESD	ESD sensitivity	human body model; R = 1.5 kΩ; C = 100 pF	500	-	V

5. Characteristics

Table 5. Characteristics

In accordance with the Absolute Maximum Rating System (IEC 60134); bandwidth 40 MHz to 870 MHz; V_B = 24 V; T_{mb} = 30 °C; Z_L = 75 Ω.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
S	responsivity					
	BGO807	λ = 1300 nm	800	-	-	V/W
	BGO807/FC0; BGO807/SC0	λ = 1300 nm	750	-	-	V/W
FL	flatness straight line (peak to valley)	f = 40 MHz to 870 MHz	-	-	1	dB
SL	slope straight line	f = 40 MHz to 870 MHz	0	-	2	dB
S ₂₂	output return losses	f = 40 MHz to 870 MHz	11	-	-	dB
	optical input return losses		45	-	-	dB
d ₂	second order distortion	f _m = 446.5 MHz	[1][2]	-	-	-66 dB
		f _m = 746.5 MHz	[1][3]	-	-	-61 dB
		f _m = 854.5 MHz	[1][4]	-	-	-55 dB
d ₃	third order distortion	f _m = 853.25 MHz	[5][6]	-	-	-71 dB

Table 5. Characteristics ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134); bandwidth 40 MHz to 870 MHz; $V_B = 24\text{ V}$;
 $T_{mb} = 30\text{ }^{\circ}\text{C}$; $Z_L = 75\text{ }\Omega$

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
F	equivalent noise input	$f = 40\text{ MHz to }450\text{ MHz}$	-	-	7	$\text{pA}/\sqrt{\text{Hz}}$
		$f = 450\text{ MHz to }750\text{ MHz}$	-	-	8	$\text{pA}/\sqrt{\text{Hz}}$
		$f = 750\text{ MHz to }870\text{ MHz}$	-	-	8.5	$\text{pA}/\sqrt{\text{Hz}}$
S_λ	spectral sensitivity	$\lambda = 1310 \pm 20\text{ nm}$	0.85	-	-	A/W
		$\lambda = 1550 \pm 20\text{ nm}$	0.9	-	-	A/W
λ	optical wavelength		1290	-	1600	nm
L	length of optical fiber; SM type; 9/125 μm					
		BGO807	1	-	-	m
		BGO807/FC0; BGO807/SC0	746	-	861	mm
I_{tot}	total current consumption (DC)		175	-	205	mA
I_{bias}	diode bias current at pin 4 (DC)		-	-	25	mA

[1] Two laser test; each laser with a modulation index of 40%; $P_{\text{opt}} = 1\text{ mW}$ (total).

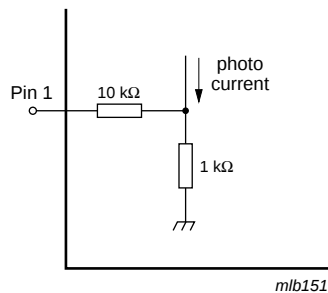
[2] $f_m = 446.5\text{ MHz}$; $f_p = 97.25\text{ MHz}$; $f_q = 349.25\text{ MHz}$.

[3] $f_m = 746.5\text{ MHz}$; $f_p = 133.25\text{ MHz}$; $f_q = 613.25\text{ MHz}$.

[4] $f_m = 854.5\text{ MHz}$; $f_p = 133.25\text{ MHz}$; $f_q = 721.25\text{ MHz}$.

[5] Three laser test; each laser with a modulation index of 60%; $P_{\text{opt}} = 1\text{ mW}$ (total).

[6] $f_m = 853.25\text{ MHz}$; $f_p = 133.25\text{ MHz}$; $f_q = 265.25\text{ MHz}$; $f_r = 721.25\text{ MHz}$.

**Fig 1. Monitor current pin.**

6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads

SOT115T

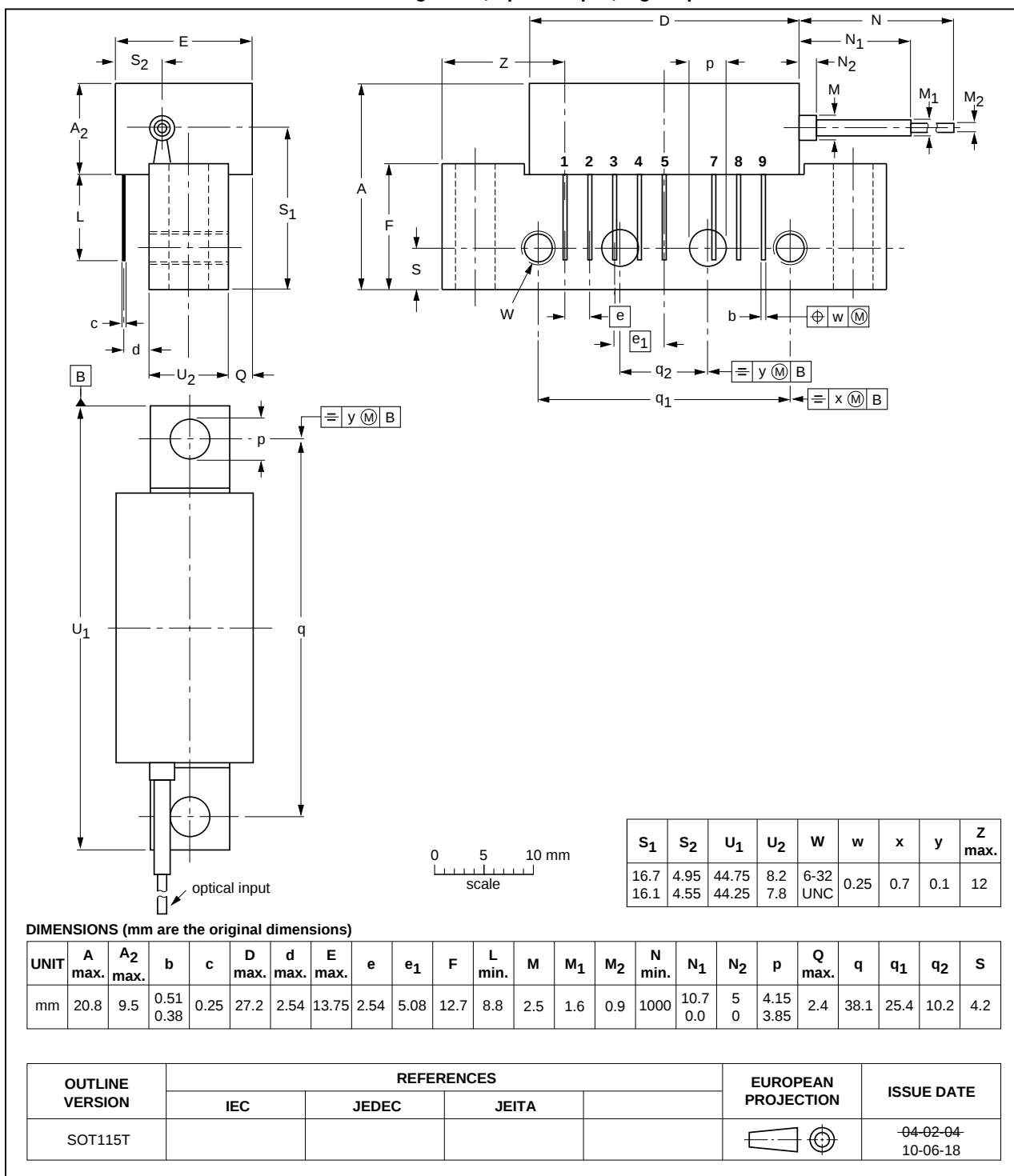
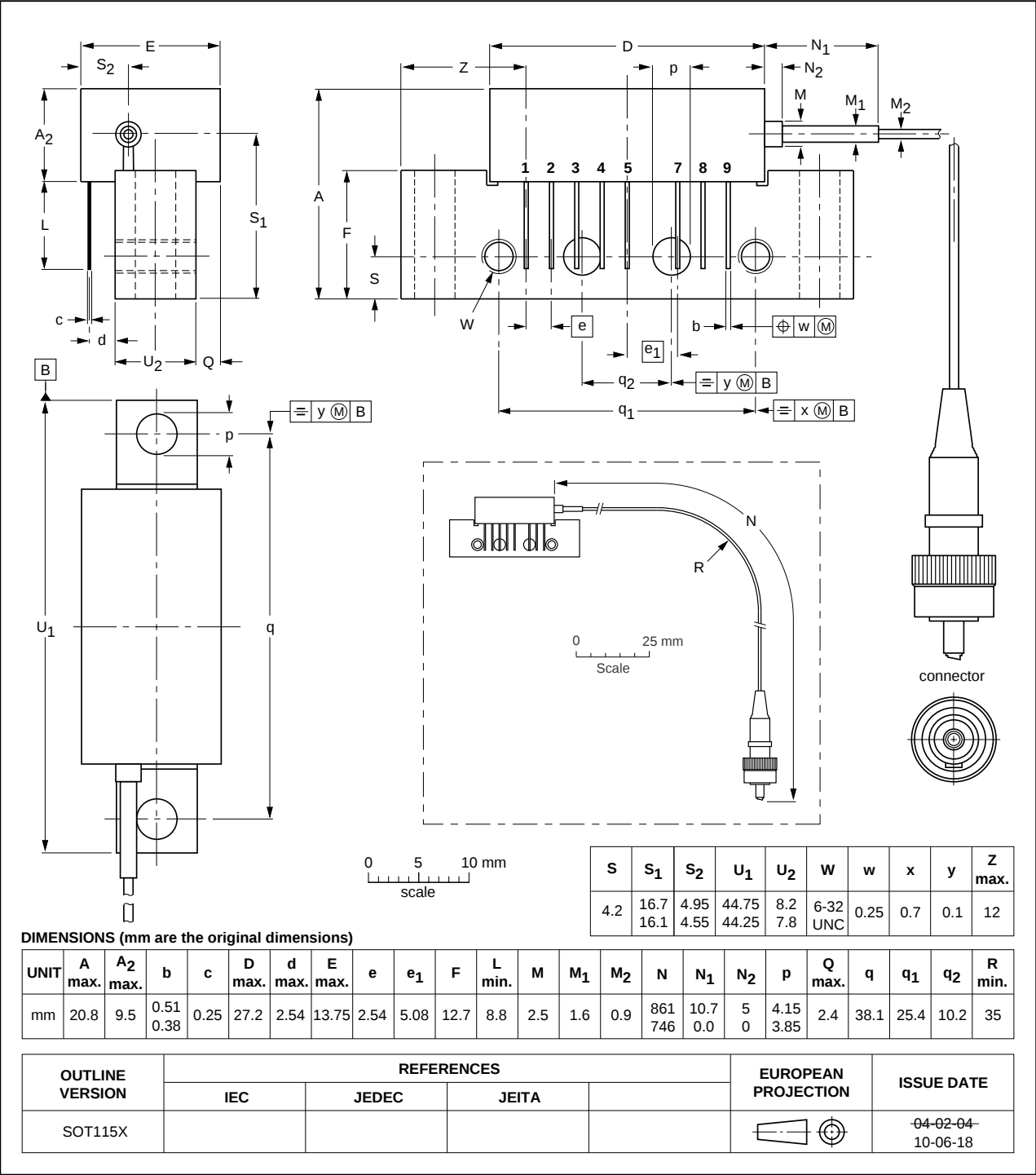


Fig 2. Package outline SOT115T.

Rectangular single-ended package; aluminium flange;
 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes;
 optical input with connector; 8 gold-plated in-line leads

SOT115X



Rectangular single-ended package; aluminium flange;
 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes;
 optical input with connector; 8 gold-plated in-line leads

SOT115Y

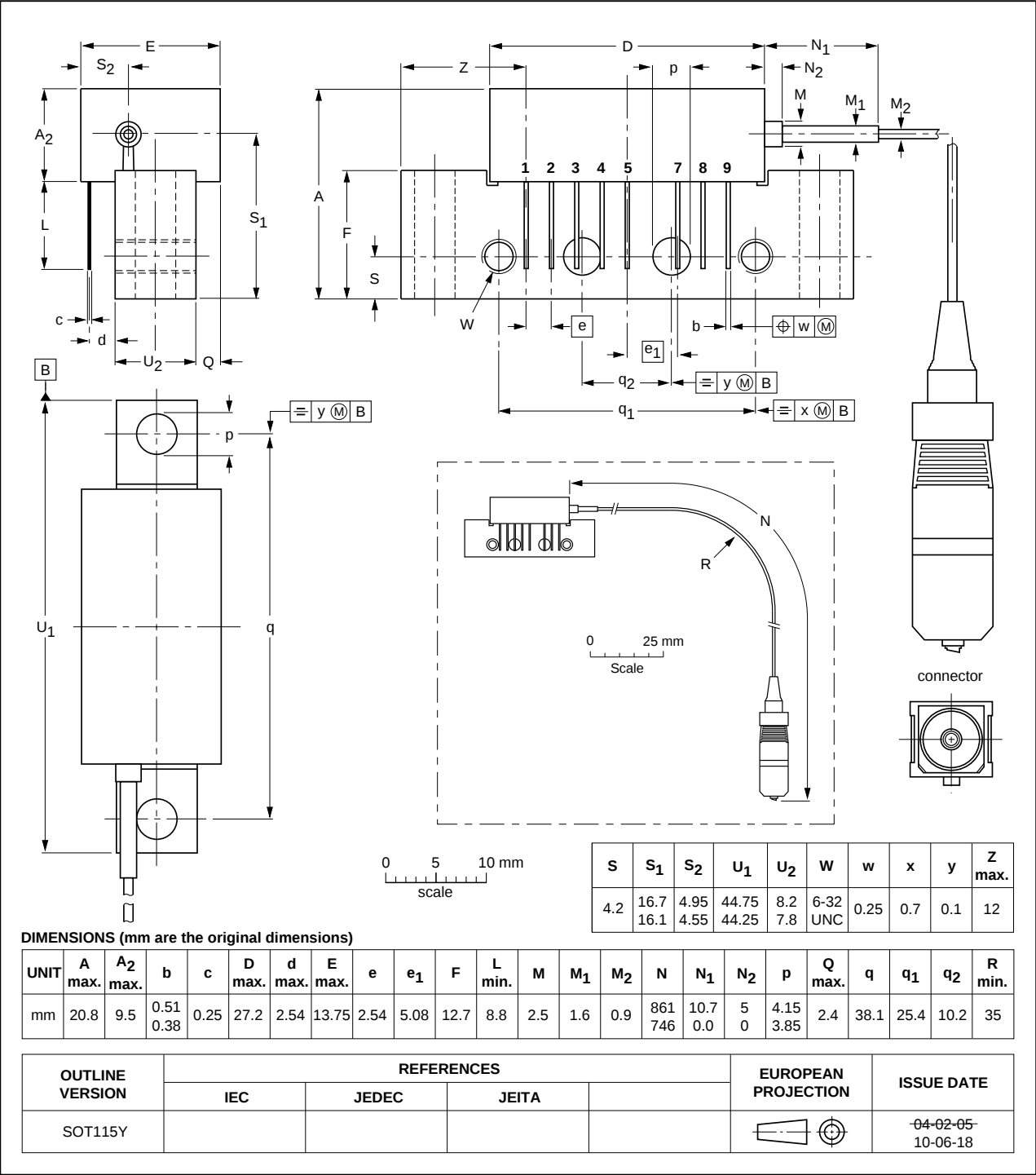


Fig 4. Package outline SOT115Y.

7. Handling information

Fiberglass optical coupling: maximum tensile strength = 5 N; minimum bending radius = 35 mm.

8. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGO807_FC0_SC0 v.2	20100929	Product data sheet	-	BGO807_FC0_SC0 v.1
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Pinning information: presentation was modified, graphic symbols were added. • Package outline and simplified outline drawings have been updated to the latest version.			
BGO807_FC0_SC0 v.1 (9397 750 13192)	20040707	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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11. Contents

1	Product profile	1
1.1	General description	1
1.2	Features and benefits	1
1.3	Applications	1
1.4	Quick reference data	2
2	Pinning information	2
3	Ordering information	3
4	Limiting values	3
5	Characteristics	3
6	Package outline	5
7	Handling information	8
8	Revision history	8
9	Legal information	9
9.1	Data sheet status	9
9.2	Definitions	9
9.3	Disclaimers	9
9.4	Trademarks	10
10	Contact information	10
11	Contents	11

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Date of release: 29 September 2010

Document identifier: BGO807_FC0_SC0